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The background of the slide is a collage of various thin-film passive components. These include several square and rectangular components with intricate gold-colored circuit patterns, some with complex interdigitated structures. There are also several larger, solid gold-colored square components. The components are arranged in a grid-like pattern, with some overlapping. A white diamond-shaped box with a thin grey border is positioned on the right side of the slide, containing the text "薄膜被動元件".

薄膜被動元件



